

## **Technical Data Sheet TOP View LEDs**

### 67-21/GHC-BT2V1/2T

#### **Features**

- P-LCC-2 package.
- White package.
- Optical indicator.
- Colorless clear window.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (8mm Tape).
- Pb-free
- The product itself will remain within RoHS compliant version.

#### **Descriptions**

• The 67-21 series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes it ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- General use.

#### **Device Selection Guide**

	Lens Color	
Material Emitted Color		
InGaN	Brilliant Green	Water Clear

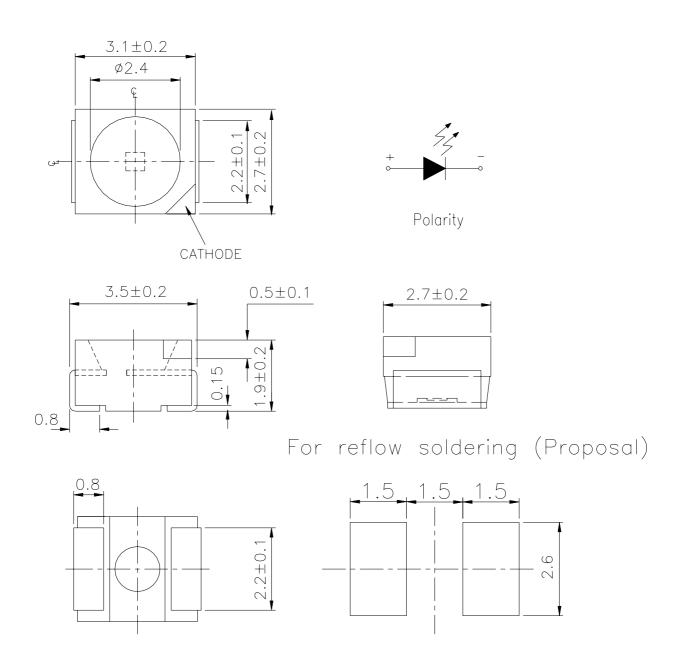


Everlight Electronics Co., Ltd. http://www.everlight.com Page: 1 of 10 Device No: DES-671-288 Prepared date: 04-Oct-2005 Prepared by: Venis Wu

Rev. 1

## 67-21/GHC-BT2V1/2T

### **Package Dimensions**



Note: The tolerances unless mentioned is  $\pm 0.1$ mm; Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 2 of 10

Device No: DES-671-288 Prepared date: 04-Oct-2005 Prepared by: Venis Wu



### 67-21/GHC-BT2V1/2T

## **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_R$	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40~ +100	$^{\circ}$ C	
Electrostatic Discharge(HBM)	ESD	150	V	
Power Dissipation	Pd	110	mW	
Peak Forward Current(Duty 1/10  @ 1KHz)	IFP	100	mA	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.		

## **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	360		900	mcd	I <sub>F</sub> =20mA
Viewing Angle	2 \theta 1/2		120		deg	I <sub>F</sub> =20mA
Peak Wavelength	λр		518		nm	I <sub>F</sub> =20mA
Dominant Wavelength	λd	523.5		533.5	nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	Δλ		35		nm	I <sub>F</sub> =20mA
Forward Voltage	VF		3.3	3.7	V	I <sub>F</sub> =20mA
Reverse Current	Ir			10	$\mu$ A	V <sub>R</sub> =5V

<sup>\*</sup>The luminous intensity data did not including ±10% testing tolerance.

Everlight Electronics Co., Ltd.

Device No: DES-671-288

http://www.everlight.com Prepared date: 04-Oct-2005

Prepared by: Venis Wu

Page: 3 of 10

Rev. 1

<sup>\*</sup>Tolerance of Dominate Wavelength ±1nm



### 67-21/GHC-BT2V1/2T

### **Bin Range Of Dominant Wavelength**

Group	Bin Code	Min.	Max.	Unit	Condition	
В	B13	523.5	525.5	nm		
	B14	525.5	527.5		I <sub>F</sub> =20mA	
	B15	527.5	529.5			
	B16	529.5	531.5			
	B17	531.5	533.5			

### **Bin Rang Of Luminous Intensity**

	<u> </u>			
Bin	Min	Max	Unit	Condition
T2	360	450	mcd	I <sub>F</sub> =20mA
U1	450	565		
U2	565	715		
V1	715	900		

#### **Notes:**

Everlight Electronics Co., Ltd.

Device No: DES-671-288

http://www.everlight.com

Rev. 1 Page: 4 of 10

Prepared date: 04-Oct-2005 Prepared by: Venis Wu

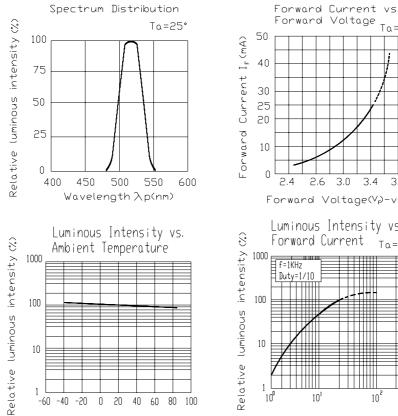
<sup>\*</sup>The luminous intensity data did not including ±15% testing tolerance.

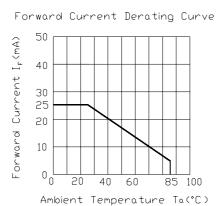
<sup>\*</sup>Tolerance of dominant wavelength ±1nm.



### 67-21/GHC-BT2V1/2T

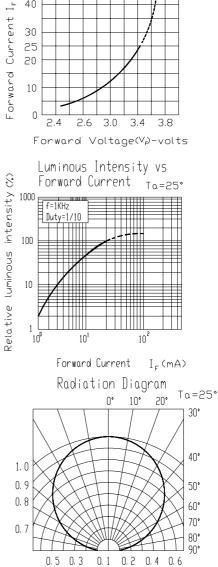
### **Typical Electro-Optical Characteristics Curves**





0 20 40

Ambient Temperature Ta(°C)



Device No: DES-671-288

Prepared by: Venis Wu



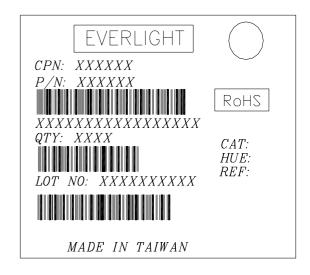
## 67-21/GHC-BT2V1/2T

### Label explanation

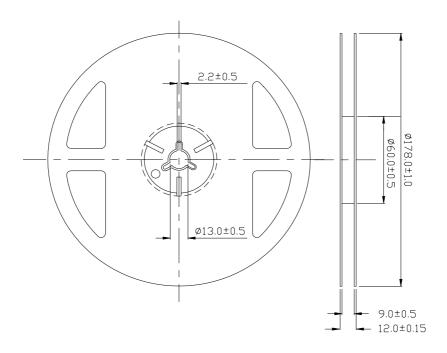
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd.

Device No: DES-671-288

http://www.everlight.com

Prepared date: 04-Oct-2005

Rev. 1

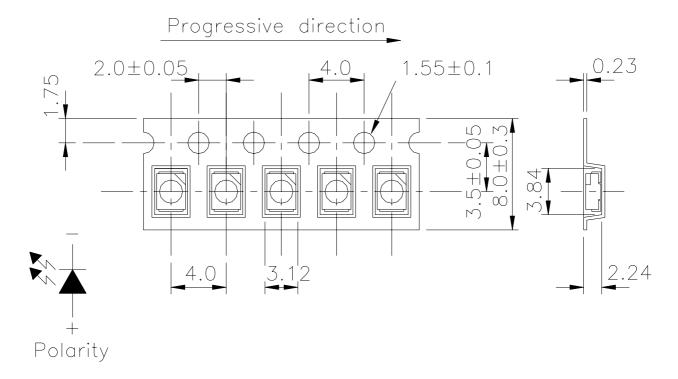
Page: 6 of 10

Prepared by: Venis Wu



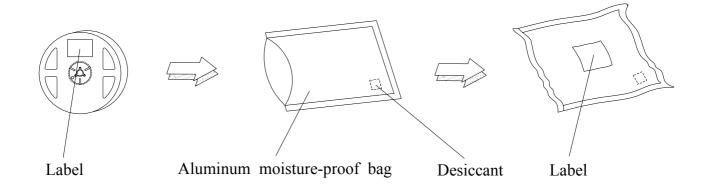
### 67-21/GHC-BT2V1/2T

### Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel.



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

### **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd.

Device No: DES-671-288

http://www.everlight.com

Prepared date: 04-Oct-2005

Rev. 1

Page: 7 of 10

Prepared by: Venis Wu



## 67-21/GHC-BT2V1/2T

## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min  ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA} / 25^{\circ}\text{C}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 8 of 10 Device No: DES-671-288 Prepared date: 04-Oct-2005 Prepared by: Venis Wu



#### 67-21/GHC-BT2V1/2T

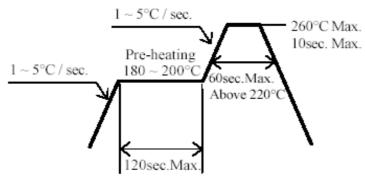
#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

    Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Lead solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron

Everlight Electronics Co., Ltd.

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

Device No: DES-671-288 Prepared date: 04-Oct-2005 Prepared by: Venis Wu

http://www.everlight.com

Rev. 1

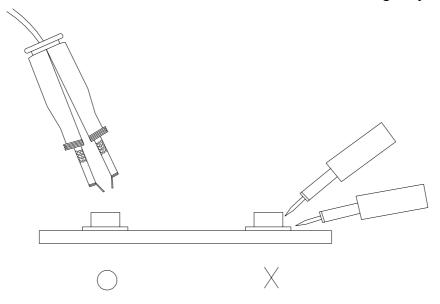
Page: 9 of 10



### 67-21/GHC-BT2V1/2T

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 10 of 10 Device No: DES-671-288 Prepared date: 04-Oct-2005 Prepared by: Venis Wu